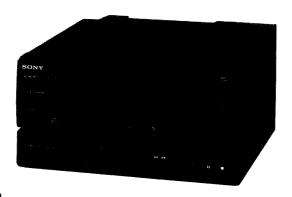
CDP-H3750

SERVICE MANUAL



US Model
Canadian Model
AEP Model
UK Model
E Model
Australian Model
Tourist Model

This set is the CD player section in FH-E705C, MHC-2750/3750.

Model Name Using Similar Mechanism	NEW
CD Mechanism Type	CDM23-5BD3
Optical Pick-Up Block Type	BU-5BD3

SPECIFICATIONS

System

Compact disc digital audio

system

Laser

Semiconductor laser $(\lambda = 780 \text{ nm})$

Emission duration: continuous

Laser output

Max. 44.6 μW*

 This output is the value measured at a distance of about 200 mm from the objective lens surface on the Optical Pick-up Block.

Signal to noise ratio

Dynamic range More than 90 dB
More than 90 dB
Harmonic distortion Less than 0.05% (at 1 kHz)
Channel separation More than 90 dB
Output level 1.6 V (at 50 kilohms)
Load impedance More than 10 kilohms

Design and specifications subject to change without notice.

For the United Kingdom and European countries.



This appliance is classified as a CLASS 1 LASER product. The CLASS 1 LASER PRODUCT label is located on the rear exterior.

SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK A OR DOTTED LINE WITH MARK A ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

ATTENTION AU COMPOSANT AYANT RAPPORT À LA SÉCURITÉ!

LES COMPOSANTS IDENTIFIÉS PAR UNE MARQUE A SUR LES DIAGRAMMES SCHÉMATIQUES ET LA LISTE DES PIÈCES SONT CRITIQUES POUR LA SÉCURITÉ DE FONCTIONNEMENT. NE REMPLACER CES COMPOSANTS QUE PAR DES PIÈCES SONY DONT LES NUMÉROS SONT DONNÉS DANS CE MANUEL OU DANS LES SUPPLÉMENTS PUBLIÉS PAR SONY.





SAFETY CHECK-OUT

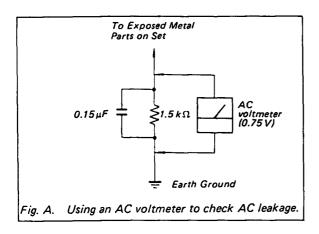
After correcting the original service problem, perform the following safety check before releasing the set to the customer:

Check the antenna terminals, metal trim, "metallized" knobs, screws, and all other exposed metal parts for AC leakage. Check leakage as described below.

LEAKAGE TEST

The AC leakage from any exposed metal part to earth ground and from all exposed metal parts to any exposed metal part having a return to chassis, must not exceed 0.5 mA (500 microampers). Leakage current can be measured by any one of three methods.

- A commercial leakage tester, such as the Simpson 229 or RCA WT-540A. Follow the manufacturers' instructions to use these instruments.
- A battery-operated AC milliammeter. The Data Precision 245 digital multimeter is suitable for this job.
- 3. Measuring the voltage drop across a resistor by means of a VOM or battery-operated AC voltmeter. The "limit" indication is 0.75 V, so analog meters must have an accurate low-voltage scale. The Simpson 250 and Sanwa SH-63Trd are examples of a passive VOM that is suitable. Nearly all battery operated digital multimeters that have a 2V AC range are suitable. (See Fig. A)



NOTES ON HANDLING THE OPTICAL PICK-UP BLOCK OR BASE UNIT

The laser diode in the optical pick-up block may suffer electrostatic breakdown because of the potential difference generated by the charged electrostatic load, etc. on clothing and the human body.

During repair, pay attention to electrostatic breakdown and also use the procedure in the printed matter which is included in the repair parts.

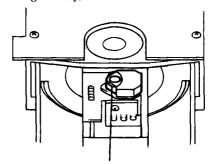
The flexible board is easily damaged and should be handled with care.

NOTES ON LASER DIODE EMISSION CHECK

The laser beam on this model is concentrated so as to be focused on the disc reflective surface by the objective lens in the optical pick-up block. Therefore, when checking the laser diode emission, observe from more than 30cm away from the objective lens.

LASER DIODE AND FOCUS SERCH OPERATION CHECK

- Make POWER switch on with no disc inserted and disc table closed.
- 2. Confirm that the following operation is performed while observing the objective lens.



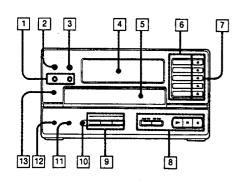
- Confirm that laser beam is spread.
- Up and down motion of the objective lens. (3 times)

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SECTION 1 GENERAL

1-1. PARTS IDENTIFICATION



This section is extracted from instruction manual.

- ☐ CHARACTER
 /b buttons ②
- 2 MEMO INPUT button (3) CURSOR button (4)
- 4 Display window
- 5 Disc tray door

- 8 CD operation buttons
 - : Stop button
 - II: Pause button
 - ⇒: Play button

(when kept depressed)/AMS* (when

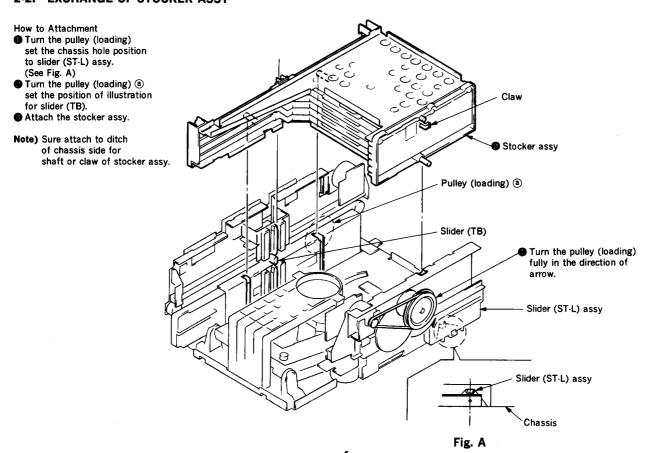
- pressed) buttons
- 9 PLAY MODE buttons PROGRAM button
 - SHUFFLE button
 - CONTINUE button
- 10 REPEAT button @
- 11 TIME/MEMO button @ @
- 12 SOUND FIELD FILE button
- 13 ERASE button 76 78

SECTION 2 DISASSEMBLY

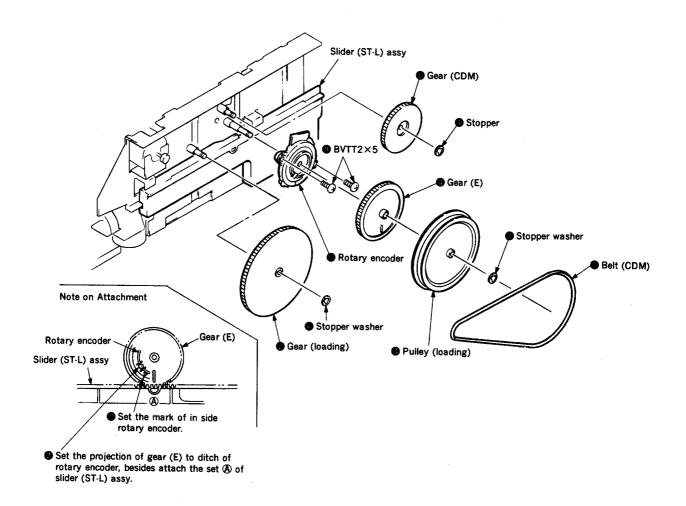
Note: Follow the disassembly procedure in the numerical order given.

2-1. REMOVE THE MAIN BLOCK **● BVT**T3×6 **Ø** BVTT3×6 Main block **❷** BVTT3×6 **O** CN213 Turn the pulley (loading) in the direction of arrow (B) and move the slider (ST-R) assy. Turn the pulley (loading) in the direction of arrow ❸ CN212 A and move the slider (ST-L) assy. Slider (ST-L) assy Transformer board block

2-2. EXCHANGE OF STOCKER ASSY



2-3. EXCHANGE OF ROTARY ENCODER

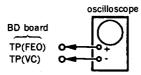


SECTION 3 ELECTRICAL BLOCK CHECKING

Note:

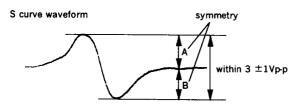
- CD Block basically constructed to operate without adjustment. Therefore, check each item in order given.
- 2. Use YEDS-18 disc (3-702-101-01) unless otherwise indicated.
- 3. Use the oscilloscope with more than $10M\Omega$ impedance.
- Clean an object lens by an applicator with neutral detergent when the signal level is low than specified value with the following checks.

S Curve Check



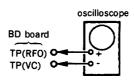
Procedure:

- Connect oscilloscope to test point TP (FEO) on BD board.
- 2. Connect between test point TP (FES) and TP (VC) by lead wire.
- Turned Power switch on and actuate the focus serch. (actuate the focus serch when disc table is moving in and out.)
- 4. Check the oscilloscope waveform (S curve) is symmetrical between A and B. And confirm peak to peak level within $3\pm 1 \rm{Vp-p}$.



- After check, remove the lead wire connected in step 2.
 Note: Try to mesure several times to make sure that the ratio of A: B or B: A is more than 10: 7.
 - Take sweep time as long as possible and light up the brightness to obtain best waveform.

RF Level Check

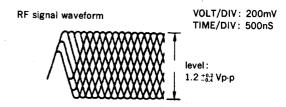


Procedure:

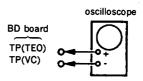
- Connect oscilloscope to test point TP (RFO) on BD board.
- 2. Turn Power switch on.
- 3. Put disc (YEDS-18) in and playback.
- Confirm that oscilloscope waveform is clear and check RF signal level is correct or not.

Note:

Clear RF signal waveform means that the shape "\$\infty" can be clearly distinguished at the center of the waveform.



E-F Balance Check



Procedure:

- 1. Connect test point TP (ADJ) to ground and TP (TES) to TP (VC) with lead wire.
- Connect oscilloscope to test point TP (TEO) on BD board.
- 3. Turn Power switch on.
- 4. Put disc (YEDS-18) in and playback.
- 5. Confirm that the osilloscope waveform is symmetrical on the top and bottom in relation to 0V, and check this level.

Traverse oscilloscope

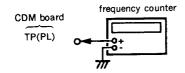


6. Remove the lead wire connected in step 1.

RF PLL Free-run Frequency Check

Procedure:

1. Connect frequency counter to test point (PL) with lead wire.



- 2. Turn Power switch on.
- 3. Confirm that reading on frequency counter is 4.3218MHz.

Focus/Tracking Gain

This gain has a margin, so even if it is slightly off.

There is no problem.

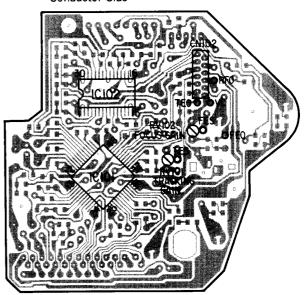
Therefore, do not perform, this adjustment.

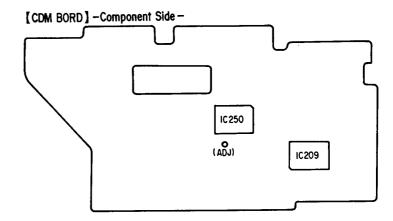
Please note that it should be fixed to mechanical center position when you moved and do not know original position.

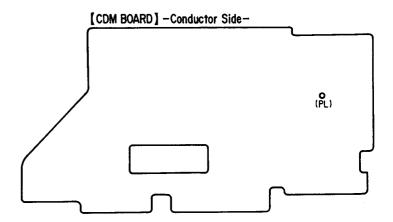
Checking Location:

[BD Board]

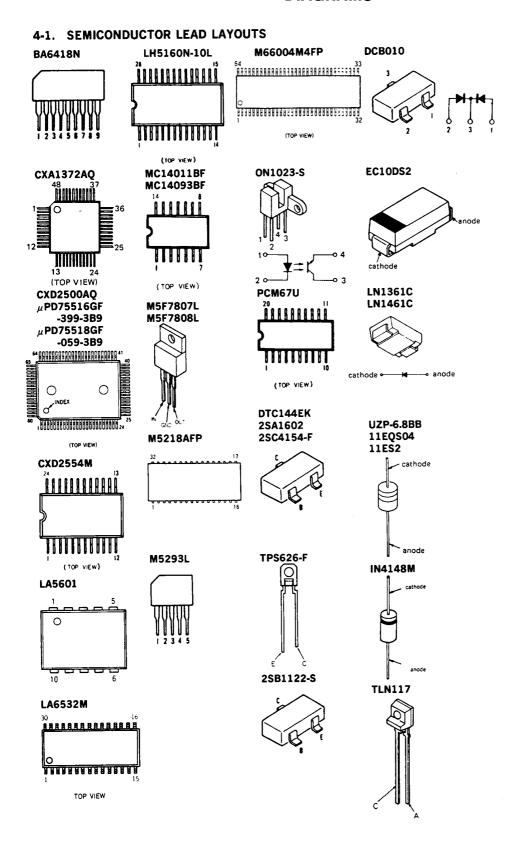
-Conductor Side-



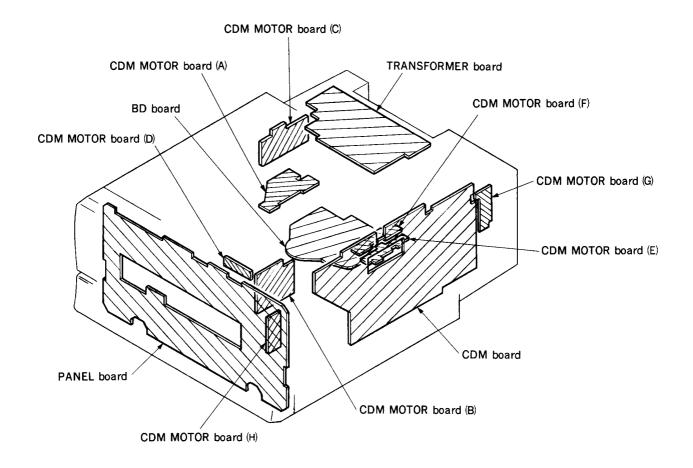




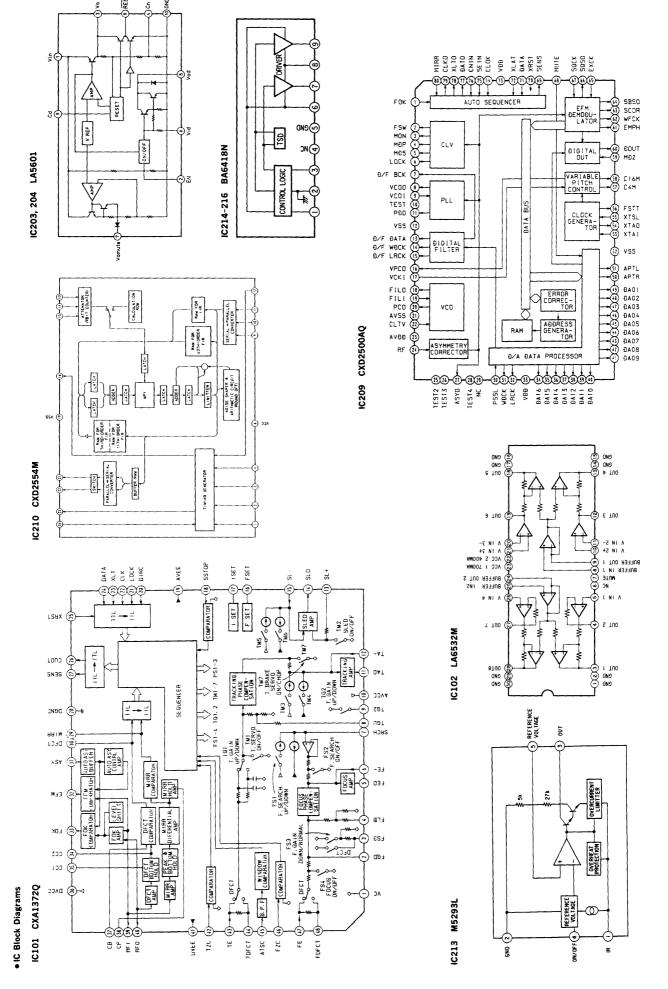
SECTION 4 DIAGRAMS

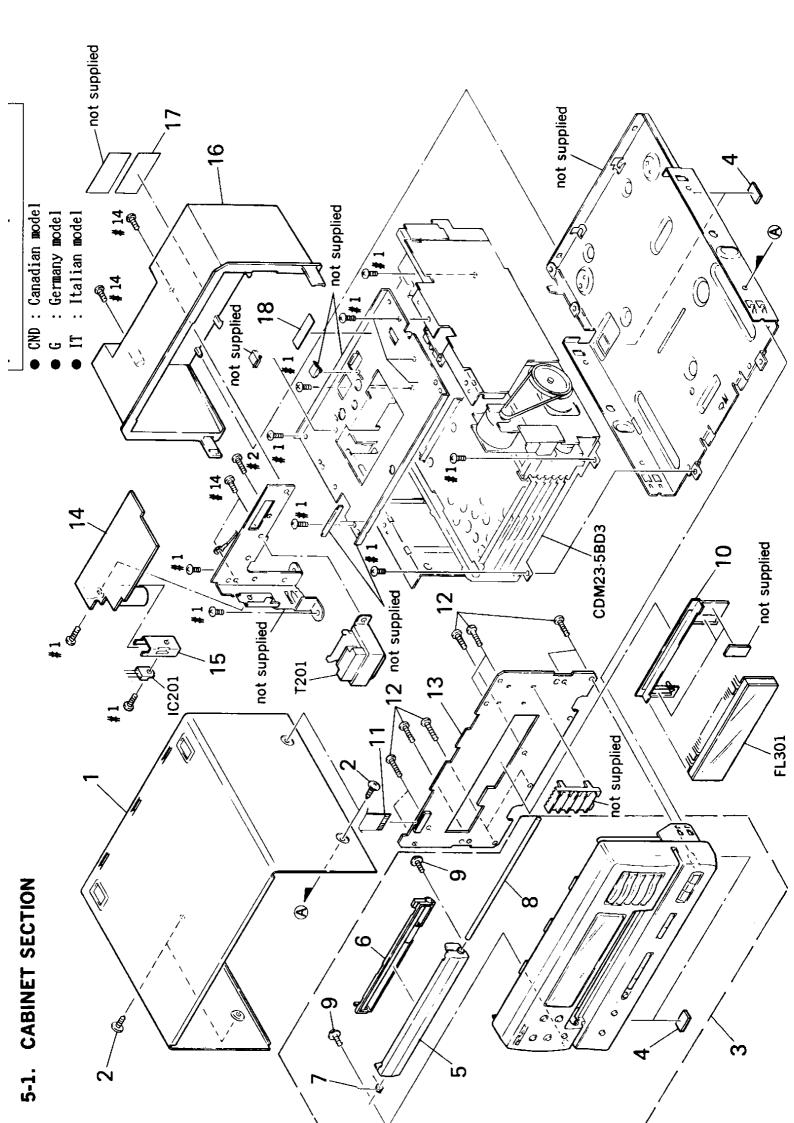


4-2. CIRCUIT BOARDS LOCATION



-18





5-2. CD MECHANISM NECTION (1) (CDM23-5BD3)

